

Rev 3.0
16.01.2024

MATERIAL SAFETY DATA SHEET

1.0 IDENTIFICATION

Product Name: (8") Silicon Wafer

General Use: Semiconductor Manufacturing

Product Description: Semiconductor Finished product

MANUFACTURE

Company Name: Tower Semiconductor LTD.

Address: POB 619 Migdal Haemek Israel 23105

Responsible Div: QA & Safety Telephone: (972) 4-6506611 Fax: (972) 4-6047035

EMERGENCY TELEPHONE NUMBER: (972) 4-6506611

2.0 COMPOSITION / INFORMATION ON INGREDIENTS

Substances / Mixture : Mixture

Composition (Element)	CAS No.	Proportion (%)	
Silicon (Si)	7440-21-3	99.60	
Other minority Dopant			
Aluminum (Al)	7429-90-5	<0.25	
Titanium (Ti)	7440-32-6	<0.04	
Indium (In)	7440-74-6	<0.002	
Tungsten (W)	7440-33-7	<0.08	
Cobalt (Co)	7440-48-4	<0.002	
Arsenic (As)	7440-38-2	<0.002	
Copper	7440-50-8	<0.002	
Boron	7440-42-8	<0.02	
Phosphorus	7723-14-0	<0.002	

3.0 HAZARDS INDENTIFICATION

Hazard effects

Human health effects: Skin contact causes irritation.

Environmental effects: NA Class name of hazard: NA

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4.0 FIRST AID MEASURES

Inhalation: NA Eye: NA

5.0 FIRE FIGHTING MEASURES

Measures: Shut off fuel as much as possible.

Equipments: Dry chemical or carbon dioxide should be used for small fire.

Fire fighters should wear proper protective clothes.

6.0 ACCIDENTAL RELEASE MEASURES

Equip extinguishers in case of ignition. Quickly shut off all ignition sources.

7.0 HANDLING AND STORAGE

Handling: Fragile-Handle with care. Shut off all sources of ignition.

Storage: Keep away all sources of ignition.

Do not heat.

Store in well-ventilated area.

Keep dry.

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8.0 EXPOSURE CONTRROLS/PERSONAL PROTECTION

EXPOSURE LIMIT VALUES: NA EXPOSURE CONTROLS Engineering controls: NA Personal protection Respiratory protection: NA

Eye protection: NA Skin protection

9.0 PHYSICAL AND CHEMICAL PROPERTIES

Appearance: Chip Color: various colors Boiling Point: Not Available Melting Point: - Not Available Density: - Not Available Vapor Pressure: - Not Available

Vapor Pressure: - Not Available Vapor Density: - Not Available Solubility in water: Insoluble

10. STABILTY AND REACTIVITY

STABILITY: Stable MATERIALS TO AVOID

11. TOXICOLOGICAL INFORMATION

Acute toxicity
Sensitization – N\A
Chronic Toxicity - N\A
Mutagen city - N\A
Carcinogenicity - N\A
IARC - N\A
NTP - N\A
OSHA - N\A
Reproductive and

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Developmental Toxicity - N\A Other - N\A

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12. ECOLOGICAL INFORMATION

ECOTOXICITY PERSISTECE AND
DEGRADABILITY BIOACCUMULATIVE
POTENTIAL -

13. DISPOSAL CONSIDERATION

Disposal method: All excess material must be collected and transferred to a

Professional waste disposal company for treatment.

Carefully review information in -7.HANDLING & STORAGE.

Special control industrial Disposal

14.0 TRANSPORT INFORMATION

UN sorts – N/A Domestic regulation – N/A Special safety measurement And condition

15.0 REGULATIORY INFORMATION

N/A

16.0 OTHER INFORMATION N/A

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